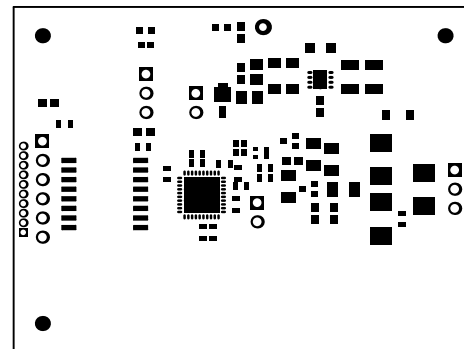
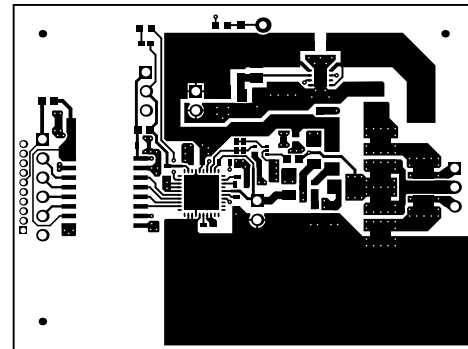


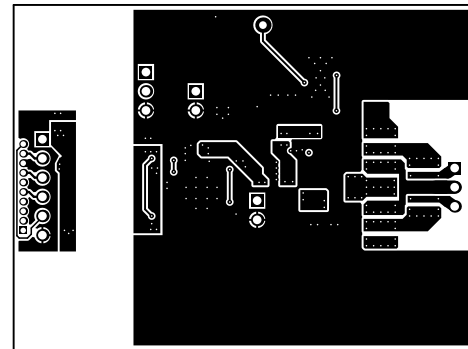
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00559		
PLOT NAME = Top Overlay	GENERATED : 3/15/2016 11:44:23 AM	TEXAS INSTRUMENTS	



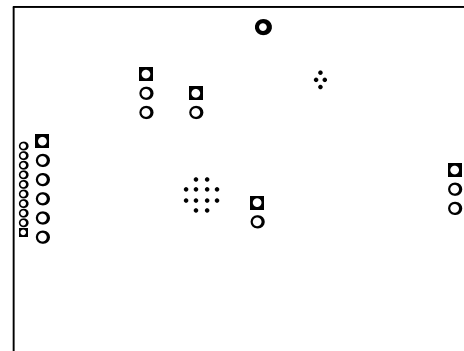
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00559		
PLOT NAME = Top Solder Mask	GENERATED : 3/15/2016 11:44:25 AM	TEXAS INSTRUMENTS	



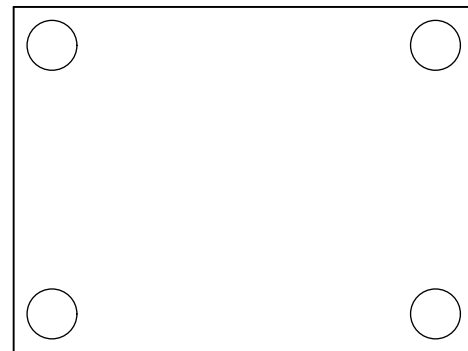
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00559		
PLOT NAME = Top Layer	GENERATED : 3/15/2016 11:44:26 AM	TEXAS INSTRUMENTS	



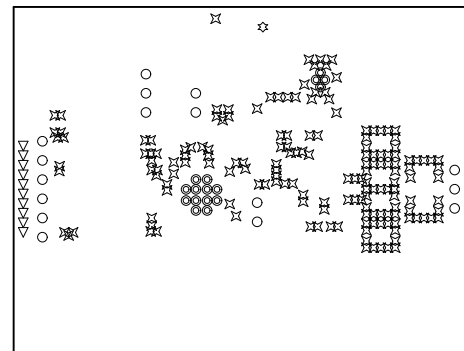
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00559		
PLOT NAME = Bottom Layer	GENERATED : 3/15/2016 11:44:28 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00559		
PLOT NAME = Bottom Solder Mask	GENERATED : 3/15/2016 11:44:30 AM	TEXAS INSTRUMENTS	

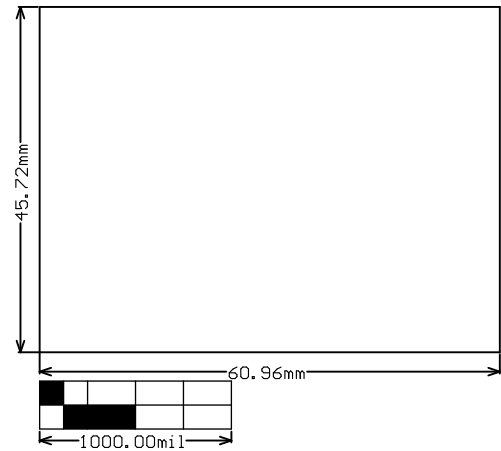


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00559		
PLOT NAME = Bottom Overlay	GENERATED : 3/15/2016 11:44:32 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Tolerance
●	16	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊠	166	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
▽	10	28.74mil (0.730mm)	PTH	Round	Top Layer - Bottom Layer	
☆	1	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
○	16	45.28mil (1.150mm)	PTH	Round	Top Layer - Bottom Layer	
	209 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00559		
PLOT NAME = Drill Drawing	GENERATED : 3/15/2016	11:44:33 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00559	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00559		
PLOT NAME = Board Dimensions	GENERATED : 3/15/2016 11:44:35 AM	TEXAS INSTRUMENTS	

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